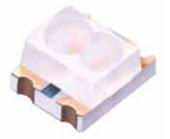


# 1.50mm Height 1210 Package With Inner Lens Bi-color (Multi-color) Chip LEDs Technical Data Sheet

Part No.: S355VUGC-2B





#### Features:

Package in 8mm tape on 7" diameter reel.Compatible with automatic placement equipment.Compatible with infrared and vapor phase reflow solder process.Bi-color type.Color: Hyper Red & Super Yellow Green.The product itself will remain within RoHS compliant Version.

#### Descriptions:

The S355 SMD LED is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.

Besides, lightweight makes them ideal for miniature applications, etc.

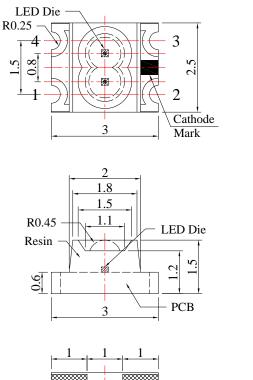
## Applications:

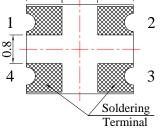
Automotive: Backlighting in dashboard and switch. Telecommunication: Indicator and backlighting in telephone and fax. Flat backlight for LCD, switch and symbol. General use.

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## Package Dimension:

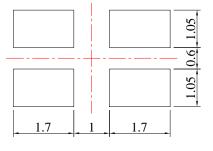




 $4 + \circ - 3$  Green  $1 + \circ - 2$  Red



**Recommended Soldering Pad Dimensions** 



Unit: mm Tolerance: ± 0.10mm

1. Soldering terminal may shift in x, y direction.

2. Polarity referring onto the cathode mark is reversed on the UR/HR/SR.

Part No.	Chip Material		Lens Color	Source Color	
S355VUGC-2B	V	AlGaInP	Watar Clear	Hyper Red	
	UG	AlGaInP	Water Clear	Super Yellow Green	

#### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm$  0.10mm (.004") unless otherwise specified.
- 3. Specifications are subject to change without notice.



# Absolute Maximum Ratings at Ta=25

Parameters	Symbol	Max.	Unit	
	Hyper Red	PD	60	mW
Power Dissipation	Super Yellow Green		60	
Peak Forward Current	Hyper Red	IFP	100	mA
(1/10 Duty Cycle, 0.1ms Pulse Width)	Super Yellow Green		100	
	Hyper Red	IF	25	mA
Continuous Forward Current	Super Yellow Green		25	
Reverse Voltage	VR	5	V	
Electrostatic Discharge (HBM)	ESD	2000	V	
Operating Temperature Range	Topr	-40 to +80		
Storage Temperature Range	Tstg	-40 to +85		
Soldering Temperature	Tsld	260 for 5 Seconds		



## Electrical Optical Characteristics at Ta=25

Parameters	Symbol	Emitting Color	Min.	Тур.	Max.	Unit	Test Condition
	IV	Hyper Red	100	200			IF=20mA (Note 1)
Luminous Intensity		Super Yellow Green	50	100		mcd	
	20 <sub>1/2</sub>	Hyper Red		60		Deg	IF=20mA (Note 2)
Viewing Angle		Super Yellow Green					
	λр	Hyper Red		632		nm	IF=20mA (Measurement @Peak)
Peak Emission Wavelength		Super Yellow Green		575			
Dominant Wavelength	λd	Hyper Red		624		nm	IF=20mA (Note 3)
		Super Yellow Green		573			
	λ	Hyper Red		20		nm	IF=20mA
Spectral Line Half-Width		Super Yellow Green		20			
	VF	Hyper Red	1.60	2.00	2.40	V	IF=20mA
Forward Voltage		Super Yellow Green	1.60	2.00	2.40		
	IR	Hyper Red			10	μΑ	V <sub>R</sub> =5V
Reverse Current		Super Yellow Green					

Notes:

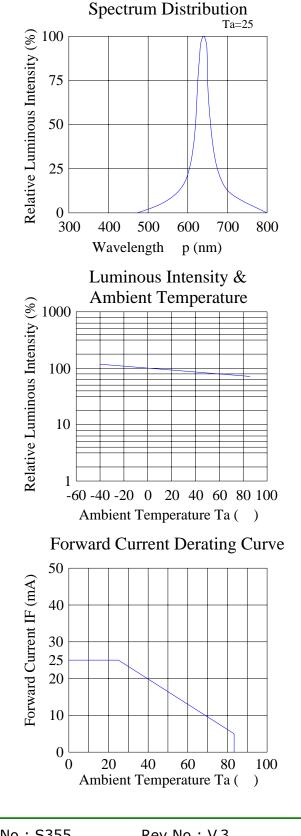
1. Luminous Intensity Measurement allowance is  $\pm$  10%.

2.  $\theta_{1/2}$  is the off-axis angle at which the luminous intensity is half the axial luminous intensity.

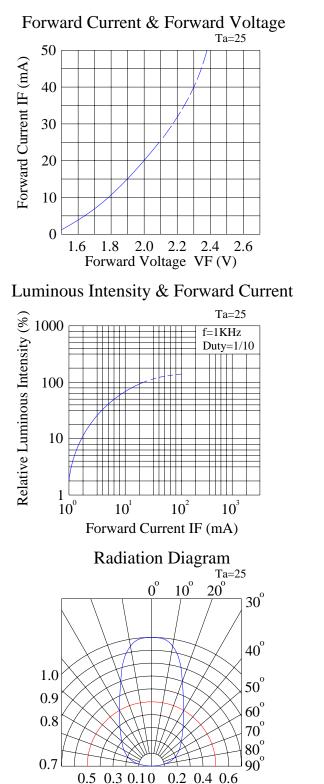
3. The dominant wavelength ( $\lambda d$ ) is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.



Typical Electrical / Optical Characteristics Curves (25 Ambient Temperature Unless Otherwise Noted) Hyper Red:





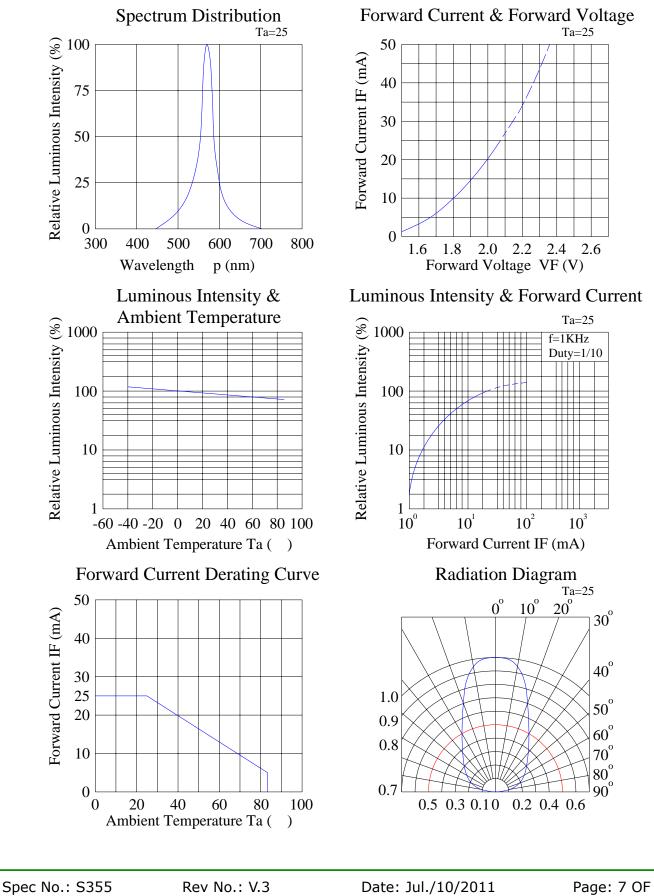


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http://www.luckylightled.com



Super Yellow Green:



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# Reliability Test Items And Conditions:

The reliability of products shall be satisfied with items listed below:

Confidence level: 90%.

LTPD: 10%.

#### 1) Test Items and Results:

No.	Test Item	Test Hours/Cycles	Test Conditions	Sample Size	Ac/Re
1	Resistance to Soldering Heat	6 Min	Tsld=260±5 , Min. 5sec	25pcs	0/1
2	Thermal Shock	300 Cycles	H:+100 5min ∫ 10 sec L: -10 5min	25pcs	0/1
3	Temperature Cycle	300 Cycles	H:+100 15min∫5min L: -40 15min	25pcs	0/1
4	High Temperature Storage	1000Hrs.	Temp: 100	25pcs	0/1
5	DC Operating Life	1000Hrs.	IF=20mA	25pcs	0/1
6	Low Temperature Storage	1000Hrs.	Temp: -40	25pcs	0/1
7	High Temperature / High Humidity	1000Hrs.	85 /85%RH	25pcs	0/1

#### 2) Criteria for Judging the Damage:

Itom	Cumbal	Test Conditions	Criteria for Judgment		
Item	Item Symbol		Min	Max	
Forward Voltage	VF	IF=20mA		F.V.*)×1.1	
Reverse Current	IR	VR=5V		F.V.*)×2.0	
Luminous Intensity	IV	IF=20mA	F.V.*)×0.7		

\*) F.V.: First Value.

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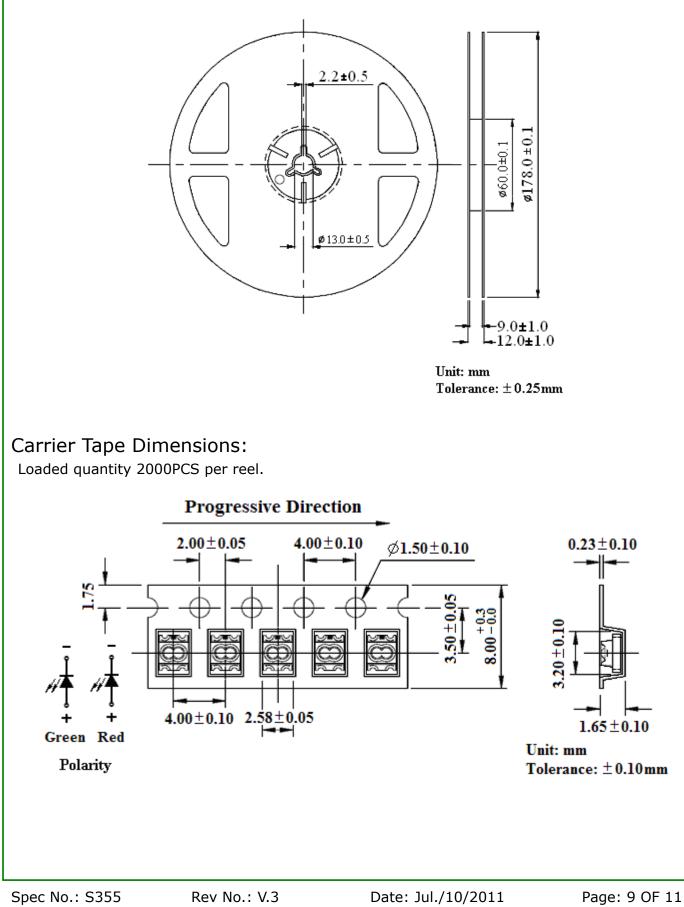


#### **Reel Dimensions:**

Approved: JoJo

Lucky Light Electronics Co., Ltd.

Checked: Wu





Please read the following notes before using the product:

## 1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

#### 2. Storage

2.1 Do not open moisture proof bag before the products are ready to use.

2.2 Before opening the package, the LEDs should be kept at 30  $\,$  or less and 80%RH or less.

2.3 The LEDs should be used within a year.

2.4 After opening the package, the LEDs should be kept at 30 or less and 60%RH or less.

2.5 The LEDs should be used within 168 hours (7 days) after opening the package.

2.6 If the moisture adsorbent material has fabled away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment: 60±5 for 24 hours.

## 3. Soldering Condition

When soldering, for Lamp without stopper type and must be leave a minimum of 3mm clearance from the base of the lens to the soldering point.

To avoided the Epoxy climb up on lead frame and was impact to non-soldering problem, dipping the lens into the solder must be avoided.

Do not apply any external stress to the lead frame during soldering while the LED is at high temperature.

Recommended soldering conditions:

Solder	ring Iron	Wave Soldering		
Temperature Soldering Time			100 Max. 60 sec. Max. 260 Max. 5 sec. Max.	

Note: Excessive soldering temperature and / or time might result in deformation of the LED lens or catastrophic failure of the LED.

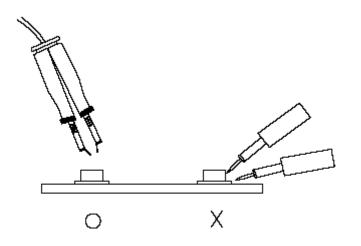
#### 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 260 for 5 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

#### 5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.





#### 6. Caution in ESD

Static Electricity and surge damages the LED. It is recommended to use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.